

Description

The LC03-6 is a 6V 100A low capacitance TVS arrays, combining a TVS diode with a rectifier bridge to provide both common and differential transient protection in one package, The LC03-6 complies with the IEC 61000-4-2 (ESD) with ±30kV air and ±30kV contact discharge. It is assembled into a 8-pin lead-free SO-8 package, the LC03-6 is rated for GR-1089, intra-building transient immunity requirements for telecommunication installations and provide overvoltage protection for applications such as 10/100/1000 BaseT Ethernet and T3/E3 interfaces.

Features

- Low capacitance for high speed interfaces
- Ultra low leakage: nA level
- Low operating voltage
- Low clamping voltage
- Protects two lines in common and differential mode
- JEDEC SO-8 package
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
 Air discharge: ±30kV
 Contact discharge: ±30kV
 - IEC61000-4-5 (Lightning) 100A (8/20µs)
- RoHS Compliant

Mechanical Characteristics

Package: SO-8

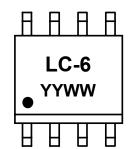
· Lead Finish: Matte Tin

- Case Material: "Green" Molding Compound.
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Below

Applications

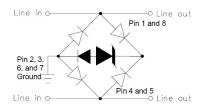
- T1/E1 Line Cards
- T3/E3 and DS3 Interfaces
- STS-1 Interfaces
- 10/100/1000 BaseT Ethernet
- ISDN Interfaces
- Low Voltage Interfaces

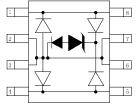
Marking Information



LC-6 = Device Marking Code YYWW = Date Code Dot denotes Pin1

Dimensions and Pin Configuration





Circuit and Pin Schematic

SO-8 Outline

Ordering Information

Part Number	Packaging	Reel Size	
LC03-6	2500/Tape & Reel	13 inch	



Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20µs)	Ppk	2000	W
Peak Pulse Current (8/20µs)	IPP	100	А
ESD per IEC 61000-4-2 (Air)	VESD	±30	kV
ESD per IEC 61000-4-2 (Contact)	VESD	±30	
Operating Temperature Range	TJ	−55 to +125	°C
Storage Temperature Range	Tstg	−55 to +150	°C

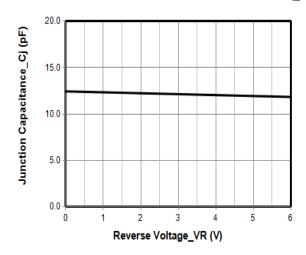
Electrical Characteristics (T_A=25°C unless otherwise specified)

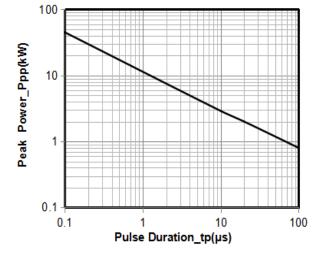
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			6	V	
Breakdown Voltage	VBR	6.8			V	IT = 1mA
Reverse Leakage Current	I _R			25	μA	VRWM = 6V
Clamping Voltage	Vc			15	V	IPP = 50A (8 x 20µs pulse), any I/O pin to ground
Clamping Voltage	Vc			20	V	IPP = 100A (8 x 20µs pulse), any I/O pin to ground
Junction Capacitance	Cı		16	25	pF	VR = 0V, f = 1MHz, between I/O pins and ground
Junction Capacitance	Cı		8	12	pF	VR = 0V, f = 1MHz, between I/O pins

Note 1: I/O pins are Pin 1, 4, 5 and 8

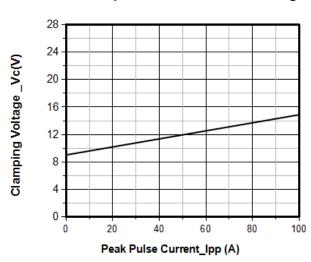


Typical Performance Characteristics (T_A=25°C unless otherwise Specified)

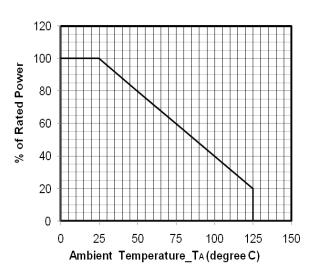




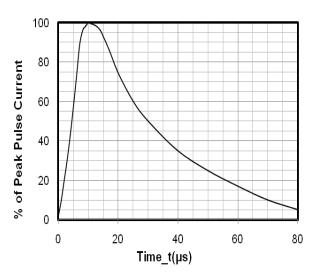
Junction Capacitance vs. Reverse Voltage



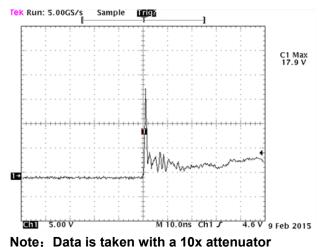
Peak Pulse Power vs. Pulse Time



Clamping Voltage vs. Peak Pulse Current (tp = 8/20us)



8 X 20µs Pulse Waveform



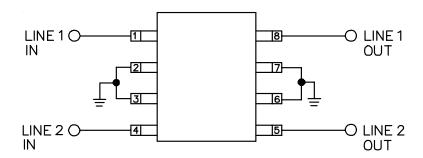
Note: Data is taken with a TOX attenuator

ESD Clamping Voltage +8 kV Contact per IEC61000-4-2

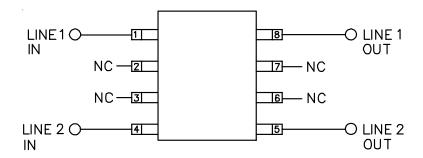


Typical Application

The LC03-6 is designed to protect two high speed data lines (one differential pair) from transient over-voltages which result from lightning and ESD. The device can be configured to protect in differential (Line to Line) and common (Line to Ground) mode. Data line inputs/outputs are connected at pins 1 to 8, and 4 to 5 as shown below. Pins 2, 3, 6, 7 are connected to ground. These pins should be connected directly to a ground plane on the board for the best results, the path length is kept as short as possible to minimize parasitic inductance. In applications where high common voltages are present, differential protection is achieved by leaving pins 2, 3, 6, and 7 not connected.



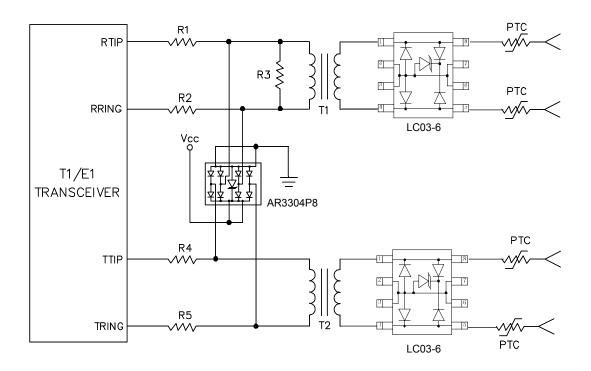
Connection for differential (Line to Line) and common mode protection (Line to Ground)



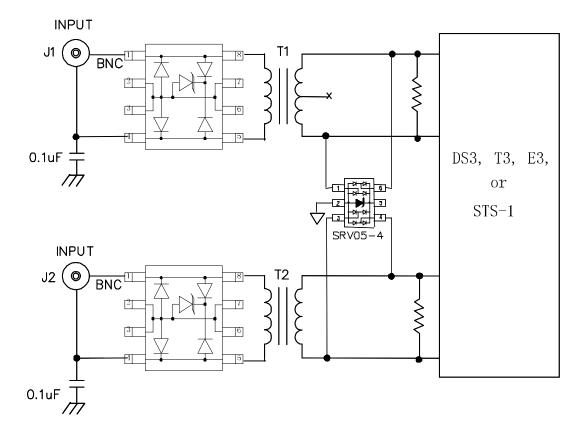
Connection for differential protection (Line to Line)



LC03-6 on T1 Line Card Application

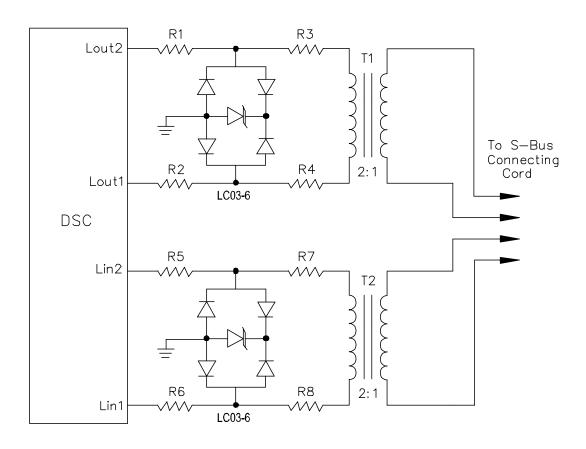


LC03-6 on T3/E3 and STS-1 Application

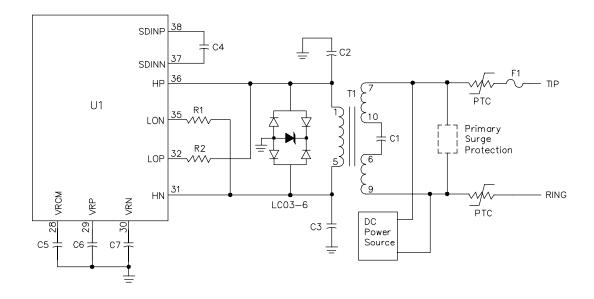




LC03-6 on ISDN S-Interface Application

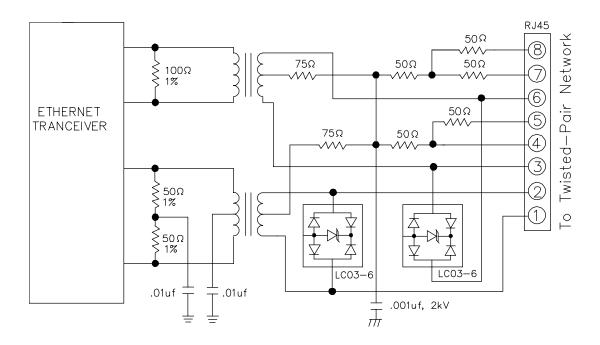


LC03-6 on ISDN U-Interface Secondary Application

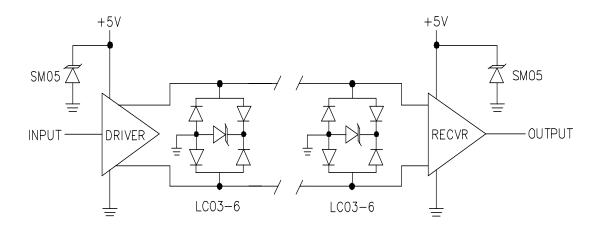




LC03-6 on 10/100 Ethernet Application

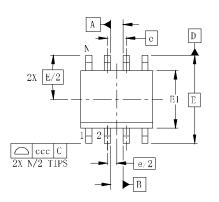


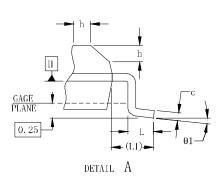
LC03-6 on High Speed Driver/Receiver Application

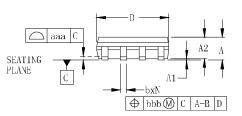


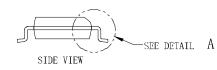


SO-8 Package Outline Drawing



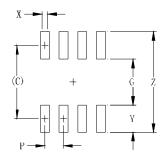






	DIMENSIONS					
SY	М	ILLIMETE	RS	INCHES		
M	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.004		0.010
A2	1.25		1.65	0.049		0.065
b	0.31		0.51	0.012		0.020
С	0.17		0.25	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E1	3.80	3.90	4.00	0.150	0.154	0.157
Е	6.00 BSC			0.236 BSC		
е		1.27 BSC		0.050 BSC		
h	0.25	0.50		0.010		0.020
L	0.40	0.72	1.04	0.016	0.028	0.041
L1	(1.04)			(0.041)		
N	8		8			
θ1	0°		8°	0°		8°
aaa	0.10			0.004		
bbb	0.25			0.010		
ccc	0.20				0.008	

Suggested Land Pattern



SYM	DIMENSIONS				
	MILLIMETERS	INCHES			
С	(5.20)	0.205			
G	3.00	0.118			
Р	1.27	0.050			
Х	0.60	0.024			
Y	2.20	0.087			
Z	7.40	0.291			

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